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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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FX30KMJ-2

High-Speed Switching Use Pch Power MOS FET

REJ03G1447-0200

(Previous: MEJ02G0283-0101)

Rev.2.00 Aug 07, 2006

Features

Drive voltage: 4 V
 V_{DSS}: -100 V

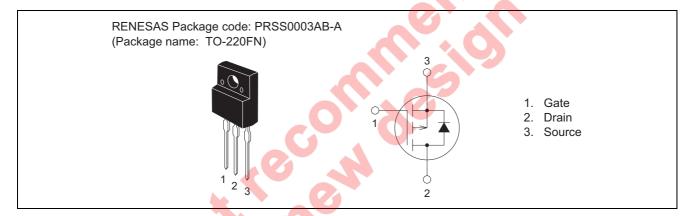
• $r_{DS(ON) \, (max)}$: 0.143 Ω

• $I_D: -30 A$

• Integrated Fast Recovery Diode (TYP.): 100 ns

• Viso: 2000 V

Outline



Applications

Motor control, Lamp control, Solenoid control, DC-DC converters, etc.

Maximum Ratings

 $(Tc = 25^{\circ}C)$

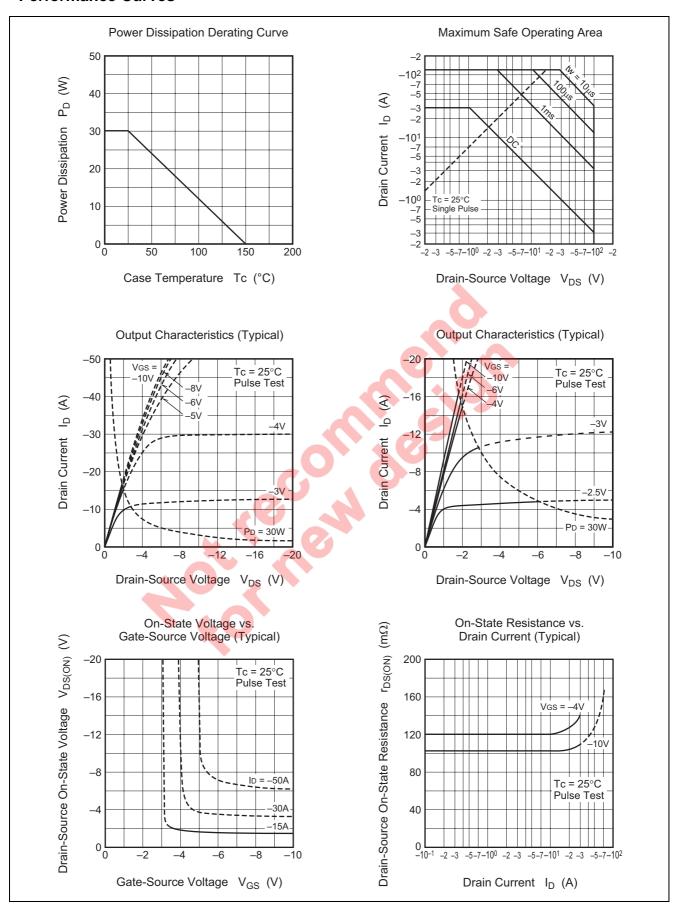
Parameter	Symbol	Ratings	Unit	Conditions	
Drain-source voltage	V_{DSS}	-100	V	V _{GS} = 0 V	
Gate-source voltage	V_{GSS}	±20	V	$V_{DS} = 0 V$	
Drain current	I _D	-30	Α		
Drain current (Pulsed)	I _{DM}	-120	А		
Avalanche drain current (Pulsed)	I _{DA}	-30	А	L = 30 μH	
Source current	Is	-30	Α		
Source current (Pulsed)	I _{SM}	-120	Α		
Maximum power dissipation	P _D	30	W		
Channel temperature	Tch	- 55 to +150	°C		
Storage temperature	Tstg	- 55 to +150	°C		
Isolation voltage	Viso	2000	V	AC for 1 minute,	
				Terminal to case	
Mass	<u> </u>	2.0	g	Typical value	

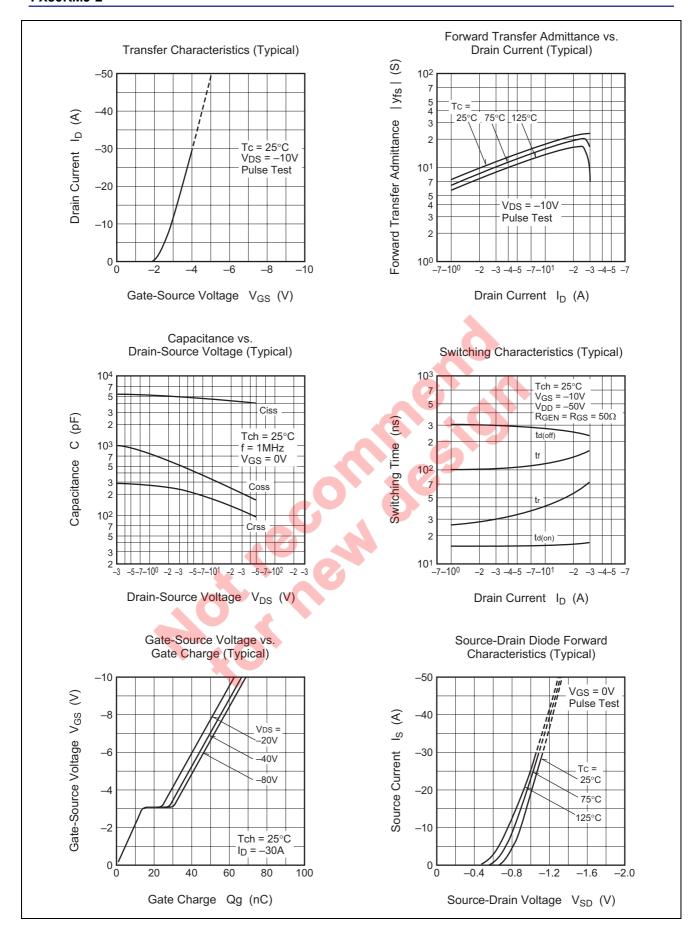
Electrical Characteristics

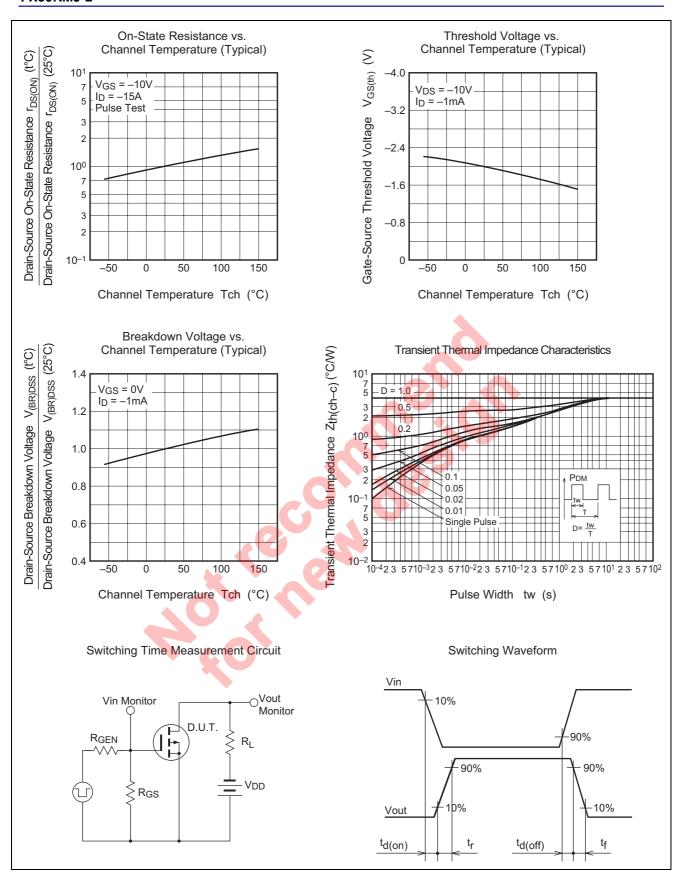
 $(Tch = 25^{\circ}C)$

Drain-source breakdown voltage Gate-source leakage current Drain-source leakage current Gate-source threshold voltage	V _{(BR)DSS}	-100	_		V	1 4 4 1/ 01/		
Drain-source leakage current	I _{GSS}			l	V	$I_D = -1 \text{ mA}, V_{GS} = 0 \text{ V}$		
		_	_ _		μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$		
Gate-source threshold voltage	I _{DSS}	_	_	-0.1	mA	$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$		
	V _{GS(th)}	-1.3	-1.8	-2.3	V	$I_D = -1 \text{ mA}, V_{DS} = -10 \text{ V}$		
Drain-source on-state resistance	r _{DS(ON)}	_	0.113	0.143	Ω	$I_D = -15 \text{ A}, V_{GS} = -10 \text{ V}$		
Drain-source on-state resistance	r _{DS(ON)}	_	0.135	0.176	Ω	$I_D = -15 \text{ A}, V_{GS} = -4 \text{ V}$		
Drain-source on-state voltage	V _{DS(ON)}	_	-1.65	-2.15	V	$I_D = -15 \text{ A}, V_{GS} = -10 \text{ V}$		
Forward transfer admittance	y _{fs}	_	20	_	S	$I_D = -15 \text{ A}, V_{DS} = -10 \text{ V}$		
Input capacitance	Ciss	_	4450	_	pF	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V},$		
Output capacitance	Coss	_	330	_	pF	f = 1MHz		
Reverse transfer capacitance	Crss	_	170	_	pF			
Turn-on delay time	t _{d(on)}	_	16	_	ns	$V_{DD} = -50 \text{ V}, I_D = -15 \text{ A},$		
Rise time	t _r	_	54	_	ns	$V_{GS} = -10 \text{ V},$		
Turn-off delay time	t _{d(off)}	_	270	_	ns	$R_{GEN} = R_{GS} = 50 \Omega$		
Fall time	t _f	_	129	_ (ns			
Source-drain voltage	V _{SD}	_	-1.0	-1.5	V	$I_S = -15 \text{ A}, V_{GS} = 0 \text{ V}$		
Thermal resistance	R _{th(ch-c)}	_	_	4.17	°C/W	Channel to case		
Reverse recovery time	t _{rr}	_	100	(4)	ns	$I_S = -30 \text{ A}, d_{is}/d_t = 100 \text{ A}/\mu \text{s}$		
Reverse recovery time t _{tr} — 100 — ns I _s = -30 A, d _{is} /d _t = 100 A/µs								

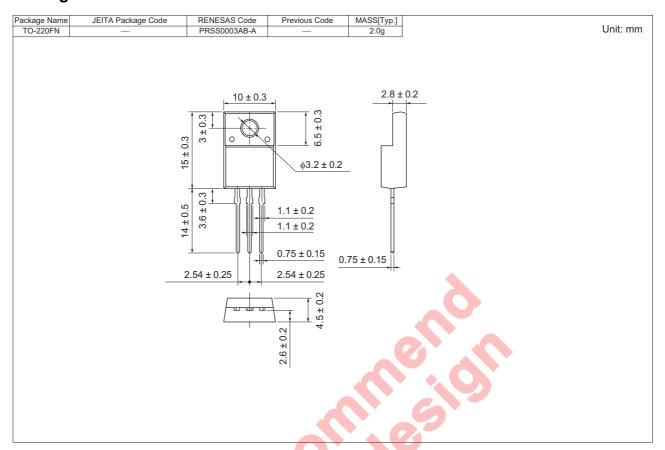
Performance Curves







Package Dimensions



Order Code

Lead form	orm Standard packing		antity	Standard order code	Standard order code example	
Straight type	Plastic Magazine (Tube)		50	Type name	FX30KMJ-2	
Lead form	Plastic Magazine (Tube)		50	Type name – Lead forming code	FX30KMJ-2-A8	

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